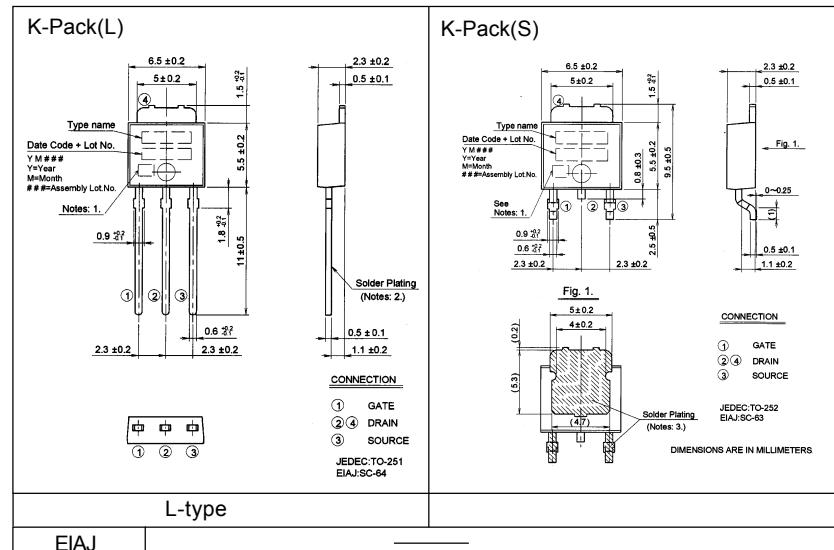


P-CHANNEL SILICON POWER MOSFET**FAP-III SERIES****■ Features**

- High speed switching
- Low on-resistance
- No secondary breakdown
- Low driving power
- High forward Transconductance
- Avalanche-proof

■ Applications

- Switching regulators
- DC-DC converters
- General purpose power amplifier

■ Outline Drawings**■ Maximum ratings and characteristics****● Absolute maximum ratings (Tc=25°C unless otherwise specified)**

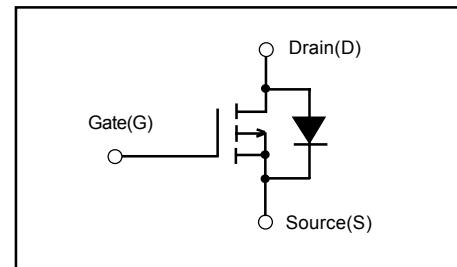
Item	Symbol	Rating	Unit
Drain-source voltage	VDS	-60	V
Drain-gate voltage (RGS=20kΩ)	VDGR	-60	A
Continuous drain current	ID	-5	A
Pulsed drain current	ID(puls)	-20	A
Gate-source voltage	VGS	±20	V
Max. power dissipation	Pd	20	W
Operating and storage temperature range	Tch	+150	°C
	Tstg	-55 to +150	°C

● Electrical characteristics (Tc =25°C unless otherwise specified)

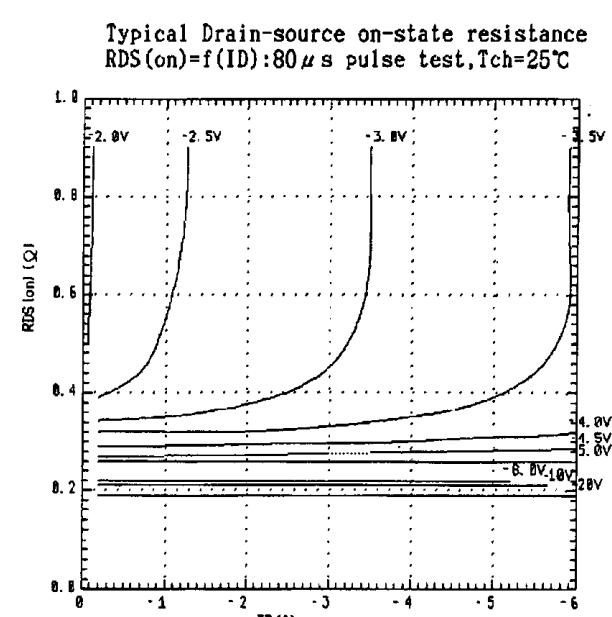
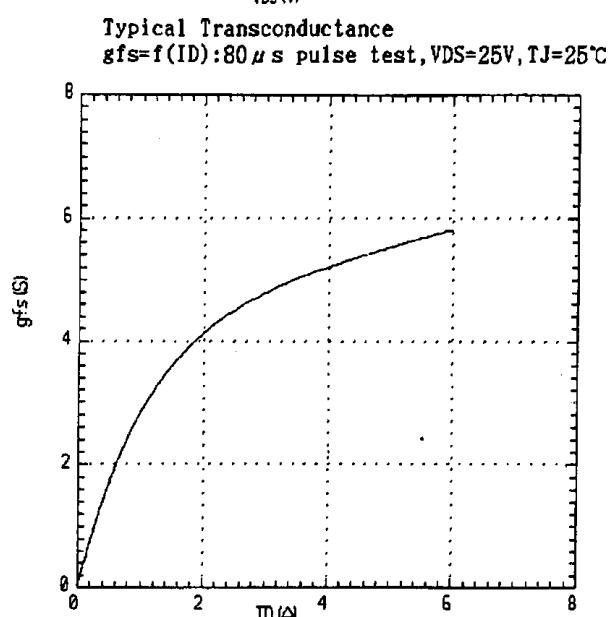
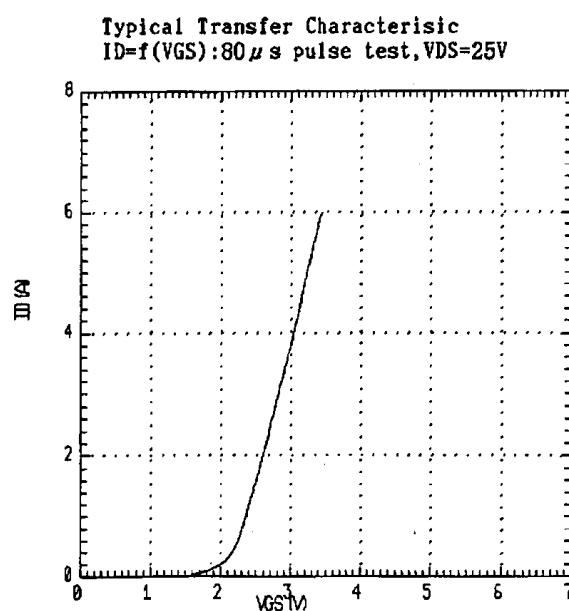
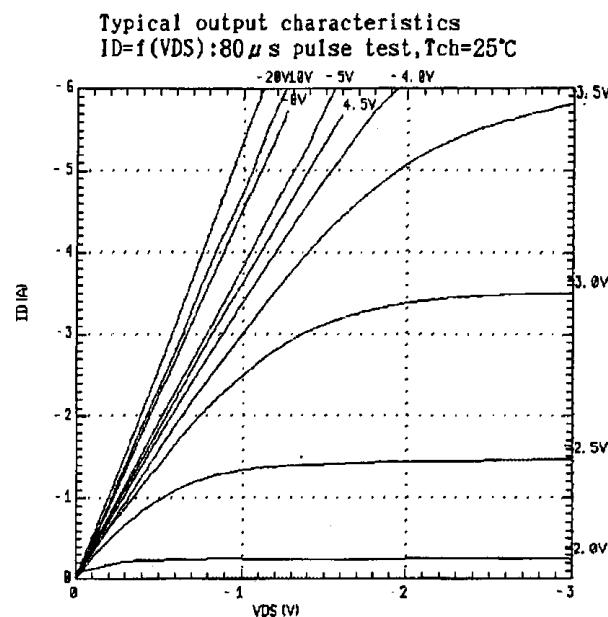
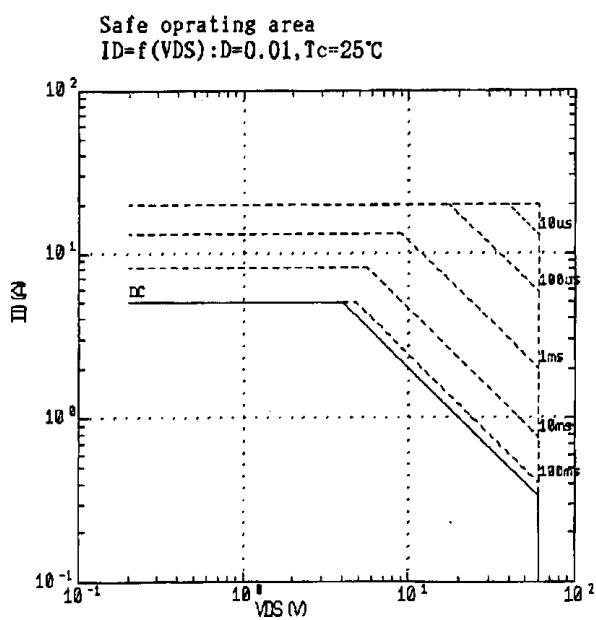
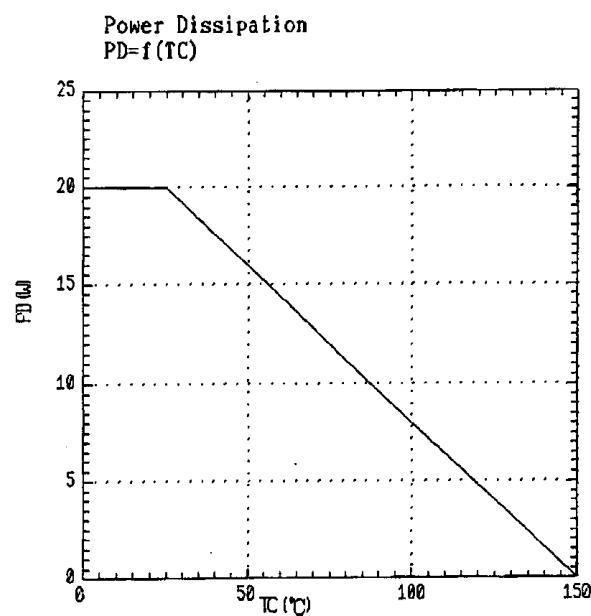
Item	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Drain-source breakdown voltage	V(BR)DSS	ID=1mA VGS=0V	-60			V
Gate threshold voltage	VGS(th)	ID=1mA VDS=VGS	-1.0	-1.5	-2.5	V
Zero gate voltage drain current	IDSS	VDS= -60V VGS=0V	Tch=25°C Tch=125°C	-10	-500	µA
Gate-source leakage current	IGSS	VGS=±20V VDS=0V		-0.2	-1.0	mA
Drain-source on-state resistance	RDS(on)	ID= -2.5A	VGS= -4V VGS= -10V	280	480	mΩ
				200	300	mΩ
Forward transconductance	gfs	ID=2.5A VDS= -25V	2.0	4.5		S
Input capacitance	Ciss	VDS= -25V VGS=0V f=1MHz	500	750		pF
Output capacitance	Coss		200	300		
Reverse transfer capacitance	Crss		120	180		
Turn-on time ton (ton=t _{d(on)} +t _r)	t _{d(on)} tr	VCC= -30V RG=25 Ω ID= -3A	15 20	23 30		ns
Turn-off time toff (toff=t _{d(off)} +t _f)	t _{d(off)} tf	VGS= -10V	100	150		
Avalanche capability	I _A V	L=100µH Tch=25°C	-5			A
Continuous reverse drain current	IDR	Tc=25°C			-5	A
Pulsed reverse drain current	IDRM	Tc=25°C			-20	A
Diode forward on-voltage	V _{SD}	IF=2xIDR VGS=0V Tch=25°C		-4.0		V
Reverse recovery time	t _{rr}	IF=IDR VGS=0V	80			ns
Reverse recovery charge	Q _{rr}	-di/dt=100A/µs Tch=25°C		0.18		µC

● Thermal characteristics

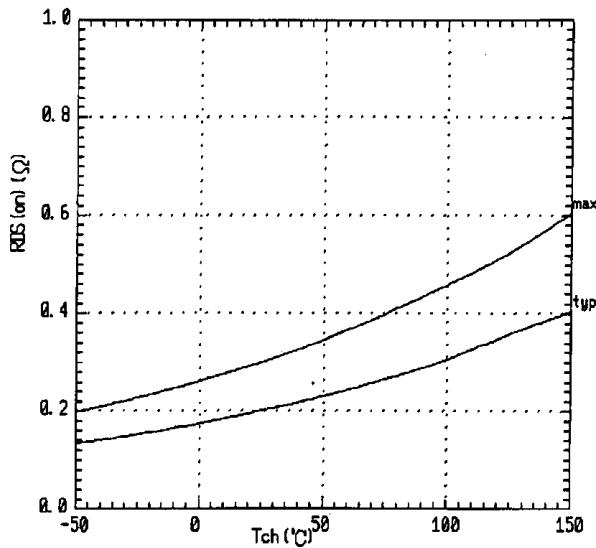
Item	Symbol	Min.	Typ.	Max.	Units
Thermal resistance	R _{th(ch-c)} R _{th(ch-a)}			6.25 125.0	°C/W

■ Equivalent circuit schematic

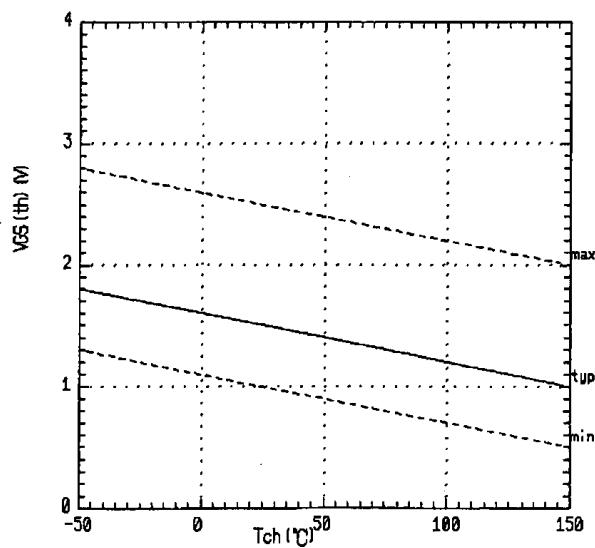
■ Characteristics



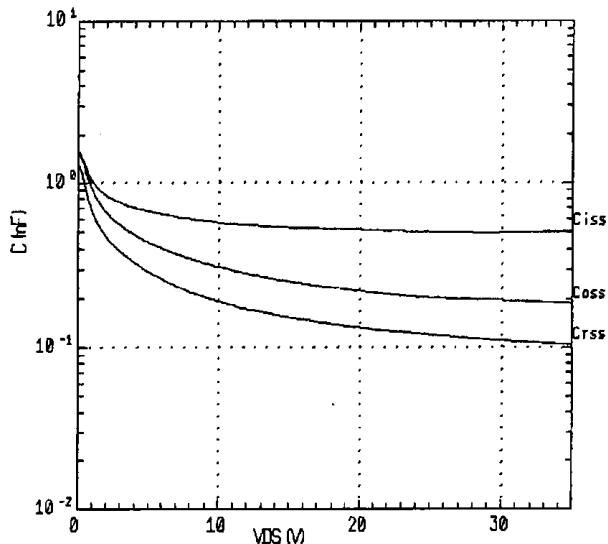
Drain-source on-state resistance
 $RDS(on)=f(Tch)$: ID=2.5A, VGS=10V



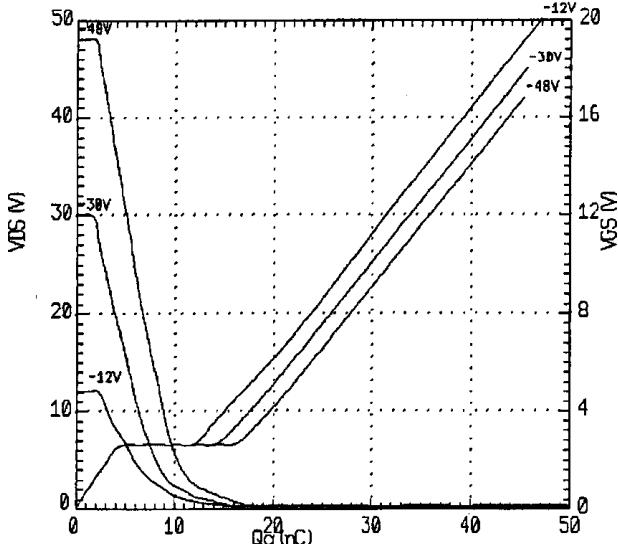
Gate threshold voltage
 $VGS(th)=f(Tch)$: VDS=VGS, ID=1mA



Typical capacitances
 $C=f(VDS)$: VGS=0V, f=1MHz



Typical gate charge characteristics
 $VGS=f(Qg)$: ID=3A



Transient thermal impedance
 $Zthch-c=f(t)$ parameter: $D=t/T$

